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Thermal conductivity of random polycrystalline BC₃ nanosheets: A step towards realistic simulation of 2D structures

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Abstract

Boron carbide nanosheets (BC₃NSs) are semiconductors possessing non-zero bandgap. Nevertheless, there is no estimation of their thermal conductivity for practical circumstances, mainly because of difficulties in simulation of random polycrystalline structures. In the real physics world, BC₃NS with perfect monocrystalline is rare, for the nature produces structures with disordered grain regions. Therefore, it is of crucial importance to capture a more realistic picture of thermal conductivity of these nanosheets. Polycrystalline BC₃NS (PCBC₃NSs are herein simulated by Molecular <u>Dynamics simulation</u> to take their <u>thermal conductivity</u> fingerprint applying ΔT of 40K. A series of PCBC3NSs were evaluated for thermal conductivity varying the number of grains (3, 5, and 10). The effect of grain rotation was also modeled in terms of Kapitza thermal <u>resistance</u> per grain, varying the <u>rotation angle</u> ($\theta/2=14.5$, 16, 19, and 25°). Overall, a nonlinear temperature variation was observed for PCBC₃NS, particularly by increasing grain number, possibly because of more phonon scattering (shorter phonon relaxation time) arising from more <u>structural defects</u>. By contrast, the heat current passing across the slab decreased. The $\underline{\text{thermal conductivity}}$ of nanosheet dwindled from $149W\,m^{-1}\,K^{-1}$ for monocrystalline BC3NS to the values of 129.67, 121.32, 115.04, and 102.78Wm-1K-1 for PCBC₃NSs having 2, 3, 5, and 10 grains, respectively. The increase of the grains rotation angle (randomness) from 14.5° to 16°, 19° and 25° led to a rise in Kapitza thermal resistance from 2×10^{-10} m² K·W⁻¹ to the values of 2.3×10^{-10} , 2.9×10^{-10} , and 4.7×10^{-10} 10-10 m² K·W⁻¹, respectively. Thus, natural 2D structure would facilitate phonon scattering rate at the grain boundaries, which limits heat transfer across polycrystalline nanosheets.